

SMD POWER COIL-JRPI 1707P SERIES

Reliability and Test Condition

Item	Performance	Test Condition			
Operating Temperature	-40°C∼+125°C (Including self - temperature rise)				
Storage temperature and Humidity range					
Electrical Performance	Test				
Inductance	Refer to standard electrical	HP4294A,CH3302,CH1320,CH1320S LCR Meter.			
RDC	characteristics list.	CH502AC, BK2840 Micro-Ohm Meter			
Saturation Current (Isat)	Approximately △L30%	Saturation DC Current (Isat) will cause L0 to drop △L(%)			
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise $\triangle T(^{\circ}C)$. 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer			
Reliability Test		·			
Life Test		Preconditioning: Run through IR reflow for 3 times. (IPC/JEDEC J-STD-020E Classification Reflow Profiles) Temperature: 125±2°C (Inductor , ambient + temp rise) Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs			
Load Humidity		Preconditioning: Run through IR reflow for 3 times. (IPC/JEDEC J-STD-020E Classification Reflow Profiles) Humidity: 85±2% R.H, Temperature: 85°C±2°C Duration: 1000hrs Min. Bead:with 100% rated current, Inductance: with 100% rated current Measured at room temperature after placing for 24±2 hrs			
Moisture Resistance	Appearance: No damage. Inductance: within±10% of initial value RDC: within ±15% of initial value and shall not exceed the specification value.	Preconditioning: Run through IR reflow for 3 times. (IPC/JEDEC J-STD-020E Classification Reflow Profiles) 1. Baked at 50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs,keep at 25°C for 2 hrs then keep at -10°C for 3 hrs 4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.			
Thermal shock		Preconditioning: Run through IR reflow for 3 times. (IPC/JEDEC J-STD-020E Classification Reflow Profiles) Condition for 1 cycle Step1: $-40\pm2^{\circ}$ C 30 ± 5 min Step2: $125\pm2^{\circ}$ C ≤ 20 S Step3: $125\pm2^{\circ}$ C 30 ± 5 min Step4: $-40\pm2^{\circ}$ C ≤ 20 S Number of cycles: 500 Measured at room fempraturc after placing for 24 ± 2 hrs.			

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Reliability Test						
Vibration		Preconditioning: Run through IR reflow for 3 times. (IPC/JEDEC J-STD-020E Classification Reflow Profiles) Oscillation Frequency: 10Hz~2KHz~10Hz for 20 minutes Equipment: Vibration checker Total Amplitude: 10g Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations)				
Bending	Appearance: No damage. Inductance: within±10% of initial value RDC: within ±15% of initial value and shall not exceed the specification value.	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.				
Shock		Peak Normal Wave Velocity Type value duration (D) form change (g's) (ms) (Vi)ft/sec SMD 50 11 Half-sine 11.3 Lead 50 11 Half-sine 11.3				
Solder ability	More than 95% of the terminal electrode should be covered with solder •	Solder: Sn96.5% Ag3% Cu0.5% Method B, 4 hrs @ 155°C dry heat Temperature: 245±5°C Dip time: 5+0/-0.5s				
Resistance to Soldering Heat		Depth: completely cover the termination Temperature(℃) Time(s) Temperature ramp/immersion and emersion rate 260±5 (solder temp) 10±1 25mm/s ±6 mm/s 1				
Terminal Strength	Appearance: No damage. Inductance: within±10% of initial value RDC: within ±15% of initial value and shall not exceed the specification value.	Preconditioning: Run through IR reflow for 3 times (IPC/JEDEC J-STD-020E Classification Reflow Profiles) With the component mounted on a PCB with the device to be tested, applyaforce >0805inch(2012mm):1kg, <=0805 inch(2012 mm):0.5kg)to the side of a device beint tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.				

Note: When there are questions concerning measurement result measurement shall be made after 48 ± 2 hours.

Of recovery under the standard condition.

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Item	Performance	Test Condition		
Soldering and Mounting				
Soldering	Mildly activated rosin fluxes are preferred. JANTEK terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.			
IR Soldering Reflow:	Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)			
Iron Reflow:	Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Fig. 2) Note: Preheat circuit and products to 150°C Never contact the ceramic with the iron tip Use a 20 watt soldering iron with tip diameter of 1.0mm 355°C tip temperature (max) 1.0mm tip diameter (max) Limit soldering time to 4~5 sec			

Fig.1 IR Soldering Reflow

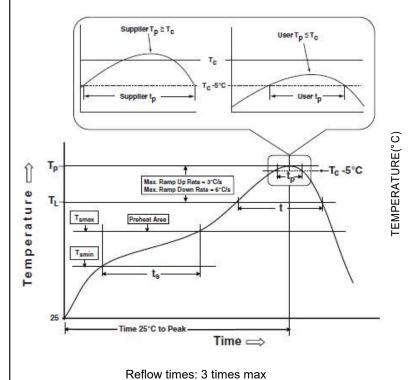
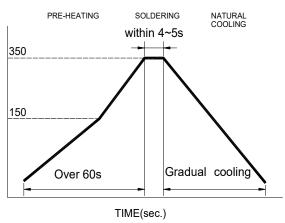


Fig.2 Iron soldering temperature profiles



Iron Soldering times : 1 times max Soldering iron Method : 350 \pm 5 $^{\circ}$ C max



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Profile Type:	Pb-Free Assembly
Preheat	
-Temperature Min(T _{smin})	150℃
-Temperature Max(T _{smax})	200℃
-Time(t_s)from(T_{smin} to T_{smax})	60-120seconds
Ramp-up rate(T _L to T _p)	3°C/second max.
Liquidus temperature(T _L)	217℃
Time(t _L)maintained above T _L	60-150 seconds
Classification temperature(T _c)	See Table (1.2)
Time(tp) at Tc- 5°C (Tp should be equal to or less than Tc.)	< 30 seconds
Ramp-down rate(T_p to T_L)	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

Tp: maximum peak package body temperature, **Tc**: the classification temperature.

For user (customer) **Tp** should be equal to or less than **Tc**.

Table (1.2) Package Thickness/Volume and Classification Temperature(Tc)

	Package	Volume mm ³	Volume mm ³	Volume mm ³
	Thickness	<350	350-2000	>2000
PB-Free Assembly	<1.6mm	260℃	260℃	260℃
	1.6-2.5mm	260℃	250℃	245℃
	≥2.5mm	250℃	245℃	245℃

Reflow is referred to standard IPC/JEDEC J-STD-020E

Notes:

- (1) When there are questions concerning measurement result : measurement shall be made after 48 \pm 2 hours of recovery under the standard condition \circ
- (2) This power choke coil itself does not have any protective function in abnormal condition such as overload, short-circuit and open-circuit conditions, etc. Therefore, it shall be confirmed as the end product that there is no risk of smoking, fire, dielectric withstand voltage, insulation resistance, etc. in abnormal conditions to provide protective devices and/or protection circuit in the end product •
- (3) When this power choke coil was used in a similar or new product to the original one, sometimes it might not be able to satisfy the specifications due to different condition of use •
- (4) Dielectric withstanding test with higher voltage than specific value will damage insulating material and shorten its life •
- (5) This power choke coil must not be used in wet condition by water, coffee or any liquid because insulation strength becomes very low in this condition •
- (6) Please consult our company to confirm the reliability of the process required to wash or use or exposure to a chemical solvent used in this product. PCB washing tested to MIL-STD-202 Method, and dry it off immediately.
- (7) The rated current as listed is either the saturation current or the heating current depending on which value is lower -
- (8) If this power choke is dipped in the cleaning agent, such as toluene, xylene, ketone, and ether system, there is a possibility that the performance decreases greatly, and marking disappearanc •
- (9) The high power ultrasonic washing may damage the choke body •
- (10) Before use , the user should determine whether this product is suitable for their own design , Our company only guarantees that the product meets the requirements of this specification ,